

EIA IBIS Open Forum Minutes

Meeting Date: **August 8, 2008**

GEIA STANDARDS BALLOT VOTING STATUS

See last page of the minutes for the voting status of all member companies.

VOTING MEMBERS AND 2008 PARTICIPANTS

Agilent	Sanjeev Gupta, Radek Biernacki, Amolak Badesha Fangyi Rao, [Ian Dodd], Yutao Hu, Vuk Borich Nobutaka Arai, Ludwig Eichinger
AMD	Nam Nguyen*
Ansoft Corporation	Steve Pytel, Ricardo Teliuteuesh, Dan Dvorscak
Apple Computer	(Bill Cornelius)
Applied Simulation Technology	(Fred Balistreri)
ARM	(Nirav Patel)
Cadence Design Systems	Terry Jernberg, Hemant Shah, Ambrish Varma [C. Kumar], Brad Griffin*, Zhen Mu
Cisco Systems	Syed Huq*, Mike LaBonte, AbdulRahman (Abbey) Rafiq Huyen Pham, Emily Yao, Susmita Mutsuddy John Fisher, Paul Ruddy, Jun Li, Jianmin Zhang Luis Boluna, Kelvin Qiu, Jane Lim, Ilyoung Park Rick Brooks, Chris Padilla, Ehsan Kabir
Ericsson	Anders Ekholm
Green Streak Programs	Lynne Green
Hitachi ULSI Systems	Kazuyoshi Shoji
Huawei Technologies	Tao Guan*, Xiaoqing Dong
IBM	Adge Hawes*
Infineon Technologies AG	Christian Sporrer
Intel Corporation	Michael Mirmak*, Rich Mellitz, Wei-hsing Huang Vishram Pandit
LSI	[Frank Gasparik], Brian Burdick*, [Kim Helliwell]
Marvell Semiconductor	(Itzik Peleg)
Mentor Graphics	Arpad Muranyi*, John Angulo
Micron Technology	Randy Wolff*
Nokia Siemens Networks GmbH	Eckhard Lenski*, Klaus Huebner, Katja Koller
Samtec	Jim Nadolny, Justin McCalister
Signal Integrity Software	Mike Steinberger, Walter Katz, Todd Westerhoff Doug Burns, Mike Mayer, Barry Katz
Sigrity	Sam Chitwood*, Brad Brim, Ben Franklin Kristopher Stytt, Raymond Chen
Synopsys	Ted Mido
Teraspeed Consulting Group	Bob Ross*, Tom Dagostino, Al Neves
Texas Instruments	Richard Ward, Pavani Jella*

Toshiba
Xilinx

ZTE

Yasumasa Kondo, Noriyasu Yoshikawa
David Banas, Ajay Shah, Suzanne Yiu
Mustansir Fanaswalla
(Ying Xiong)

OTHER PARTICIPANTS IN 2008

Aeroflex Metelics
Aica Kogyo
Altera
Avago Technologies
Bayside Design
Celestica
ECL Advantage
EFM
Elma Bustronic
Exar
Flextronics
Freescale
GEIA
Golden Bridge Networks
ICT Solutions
Interface Technologies
IO Methodology
JEITA
Magma DA
NEC
NetLogic Microsystems
North Carolina State University
Nokia
Nuova Systems
Prentice Hall
Physware
Politecnio di Torino
Qimonda AG
Siemens AG
Simberian
SimLab Software GmbH
Tektronix
TietoEnator GmbH
Tyco Electronics
Vertical Circuits
Xsigo Systems
Zuken
Independent

David Nguyen
Akihiro Tanaka
Ravindra Gali, Jing Wu, John Oh, Hui Fu
Minh Quach, Sari Tocco
Elliot Nahas, Kevin Roselle
Ihsan Erdin
Thomas Iddings
Ekkehard Miersch
Michael Munroe
Helen Nguyen
Hasnain Syed
Jon Burnett
(Chris Denham)
Saman Sadigh
Steven Wong
Dan Waterloo
Lance Wang*, Zhi (Benny) Yan, Li (Kathy) Chen
Atsushi Ishikawa
Anand Ramalingam
Takeshi Watanabe
Eric Hsu
Paul Franzon
Ali Arsian
Zhiping Yang
Bernard Goodwin
Marc Kowalski
Igor Stievano
Md Morshed Alam Heial, Suhas Jawale
Manfred Maurer, Annika Woehner
Yuriy Shlepnev
Heiko Grubrich
Steve Corey
Heinz-Hartmut Ibowski
Chad Morgan
Mark Egbers
Robert Bada
Michael Schaedler, Ralf Bruening
Guy de Burgh, Ardy Forouhar, Dave Galloi

Kazuhiko Kusunoki

In the list above, attendees at the meeting are indicated by *. Principal members or other active members who have not attended are in parentheses. Participants who no longer are in the organization are in square brackets.

UPCOMING MEETINGS

The bridge numbers for future IBIS teleconferences are as follows:

Date	Telephone Number	Meeting ID
August 29, 2008	1-866-432-9903	121149441

All meetings are 8:00 AM to 9:55 AM US Pacific Time. Meeting agendas are typically distributed seven days before each Open Forum. Minutes are typically distributed within seven days of the corresponding meeting. When calling into the meeting, press 1 to attend the meeting, then follow the prompts to enter the meeting ID. For new, local international dial-in numbers, please reference the bridge numbers provided by Cisco Systems at the following link:

http://www.cisco.com/web/about/doing_business/conferencing/index.html

NOTE: "AR" = Action Required.

INTRODUCTIONS AND MEETING QUORUM

Pavani Jella introduced herself. She has worked with IBIS models for several years, including previously at Micron and now at Texas Instruments.

CALL FOR PATENTS

Michael Mirmak called for any patents or pending patents related to the IBIS Version 3.2, 4.0, 4.1, 4.2, or ICM 1.1 specifications. No patents were declared.

MEMBERSHIP UPDATE AND TREASURER'S REPORT

Michael Mirmak reported that membership remains officially at 29 with a few renewals still being processed. Revenue is above expenses and is expected to remain so for the rest of the year. We have been informed by the GEIA that, as part of their reorganization and merger with ITAA, they will be using internal accounting teams rather than their current third-party support. This plus elimination of income pooling ("lockbox") means that financial transactions will be more easily tracked and feedback should be faster.

REVIEW OF MINUTES AND ARS

Michael Mirmak called for comments regarding the minutes of the July 18, 2008 IBIS Open Forum teleconference. The minutes were approved without changes.

WEB PAGE UPDATES

Syed Huq reported that changes have been made to the roster and events pages including additional China Summit information. More updates are coming.

MAILING LIST ADMINISTRATION

Bob Ross reported that everything is working normally.

MODEL LIBRARY UPDATE

Lance Wang is planning in a few weeks to review all the links and ask for updates to any missing or broken links. Bob Ross noted that the newly formed company Numonyx has many new models on their site found at:

<http://www.numonyx.com/EN-US/RESOURCECENTER/Pages/ModelingTools.aspx>

Arpad Muranyi mentioned that he was browsing the ICM specification and found a broken link in it. He asked how we should handle broken links in the specifications. Michael Mirmak asked that this get discussed later in the meeting.

PRESS UPDATE

No update.

MISCELLANY/ANNOUNCEMENTS

No update.

OPENS FOR NEW ISSUES

Michael Mirmak brought up a topic related to GEIA and ITAA. The logo used in the IBIS Open Forum official publications mentions EIA. GEIA is not associated with EIA anymore, and as such, the logo should probably be changed. We could use the phrase "Standards and Technology" instead of GEIA or ITAA. We can look into creating a whole new logo too. Bob Ross suggested having no affiliation on the logo and designing a new logo that prints well in both color and black and white. Michael will add this as an agenda topic for future meetings.

INTERNATIONAL/EXTERNAL PROGRESS

- DASC

Michael Mirmak had no update, but he mentioned that a recent EE Times editorial gave some background information on DASC. The DASC file and e-mail archive may be found at:

<http://www.dasc.org/>

Arpad Muranyi mentioned that the Accellera group finished up version 2.3 of the Verilog-AMS specification. Michael asked what the relationship of Accellera is to IEEE and other standards bodies. Do they submit documents to other standards bodies such as IEEE for publication? Arpad was not sure about this. Michael took the AR to find out. Arpad asked if this meant that the official Verilog-AMS language supported by IBIS is now version 2.3. Michael and Bob Ross felt that this was true so that the newest features could be supported by IBIS, but this is up to each EDA vendor to support new features if desired.

- P1735 Encryption

No update. The IEEE DASC Study Group on Encryption web reflector archives are found at:

<http://www.eda-stds.org/ip-encrypt/hm/>

IEC APPROVAL ACTIVITIES

Randy Wolff noted that he has emailed Dennis Brophy a second time as a follow-up to his conversation with John Messina. He asked Dennis to help him complete a Work Item Proposal for the next WG2 meeting; however, he still has not received a response.

Michael Mirmak and Bob Ross noted that Victor Berman, the DASC chair, is also a Technical Activities Group (TAG) chair for the IEC. He is a US representative. Randy took the AR to contact him to see if he can be of any assistance.

SUMMIT STATUS

- Asian Summits Planning

Michael Mirmak noted that the Japan summit will be held at JEITA headquarters November 14, 2008. Bob Ross mentioned that the new headquarters offers a larger meeting room than last year. An official announcement has been sent out for the Asian Summits. Bob Ross or Kazuyoshi Shoji should be contacted if planning to attend the Japan summit. The China summit contacts are Bob Ross and Lance Wang. We are close to having contracts signed to finalize the location for the China summit. The China summit will be held November 11, 2008.

- DesignCon Planning

Michael Mirmak mentioned that the DesignCon event is scheduled for February 2-5, 2009 at the Santa Clara Convention Center in Santa Clara, California. Thursday, February 5, 2009 is tentatively scheduled for the summit. Michael mentioned that some logos for the summit booth need to be updated.

Sponsorship opportunities for all upcoming IBIS summits are available, with sponsors receiving free mentions in the minutes, agenda, and other announcements. Contact the IBIS Board for further details.

IBIS QUALITY TASK GROUP

Bob Ross reported that the group is discussing I-V table specifications with respect to On-Die Termination and double counting. They plan to write a section for the quality checklist to cover

series switch models after release of the regular checklist. Eckhard Lenski added that the committee will also add series element checks.

The Quality Task Group checklist and other documentation can be found at:

http://www.eda-stds.org/ibis/quality_wip/

IBIS MODEL REVIEW TASK GROUP

No update.

ADVANCED TECHNOLOGY MODELING TASK GROUP

Arpad Muranyi reported that group discussion is continuing on EMD and EBD extension proposals. Walter Katz made a list of SPICE elements to consider including in the new proposal. Arpad is soliciting feedback on this list of elements to make sure it is sufficient for the modeling proposals.

Task group material can be found at:

http://www.eda-stds.org/ibis/macromodel_wip/

AD HOC TASK GROUPS (INTERCONNECT)

Michael Mirmak reported that the group is meeting weekly and is reviewing Touchstone 2.0 draft language. They have a draft specification to take care of mixed mode data.

Task group material can be found at:

<http://www.eda.org/ibis/adhoc/interconnect/>

NEW ISSUES

Arpad Muranyi noted that one of the web references to the drawings that help with visualizing connectors in the ICM specification is broken. The broken link exists on page 32 of the specification. Michael Mirmak noted two options. One is to make reference to drawings in other specifications. The second option is to move the specification into another format besides ASCII text that would allow drawings to be placed into the specification document. Arpad didn't think this was important enough to make any changes; he just wanted to make a note of it.

BIRD111: EXTENDED USAGE OF EXTERNAL SERIES COMPONENTS IN EBDS

Bob Ross noted that the example in the BIRD was incorrect, and he is working with Michael Schaefer to introduce a BIRD111.1. Bob has concerns with the series elements. One thing constrained by the original EBD specification is dealing with differential nets. The proposal is to allow a node connection in one path and pick up the other node in a second path. The second

example in the BIRD shows a structure that exists in some EBD files already available and IBISCHK does not catch the specification problem. There is concern is that the BIRD does not address the problem of differential buffers, and text concerning this may need to be added.

IBIS 5.0 DRAFT REVIEW

Michel Mirmak issued a call for comments regarding the draft document. Bob noted that the website has been cleaned up to show only the newest draft at the top level. A vote will be scheduled for approval of IBIS 5.0 as an official IBIS specification at the next meeting. All votes sent by email proxy or received during the meeting will count towards the official vote tally. Michael noted that he will issue a press release once the specification is finalized. Bids will then be solicited for IBISCHK parser development.

The text of the draft specifications is available at the following link:

http://www.eda.org/pub/ibis/ver5.0_wip/

IBISCHK4 BUG STATUS

BUG99 and BUG101 are still open and will be fixed in the next revision of the parser.

The BUG report list is available at the link below:

<http://www.eda.org/ibis/bugs/ibischk/>

ICMCHK1 BUG STATUS

Michael Mirmak has created a draft parser that fixes BUG4. He is looking for feedback. A test case needs to be included in the parser before official release. This will be version 1.1.3.

NEW TECHNICAL ISSUES

Michael Mirmak referenced the section in [Model Spec] that deals with hysteresis. The specification defines a rising edge region between Vinh- and Vinh+ and a falling edge switching region between Vinl+ and Vinl-. He showed the ATAPI specification. This spec labels V+ and V- thresholds. The IBIS specification names were probably named with reference to the other IBIS parameters Vinh and Vinl. These names probably should be named more consistently with the ATAPI specification.

Arpad Muranyi requested time at the next meeting for discussion on min/max conditions for clamps as relates to corners.

NEXT MEETING

The next IBIS Open Forum teleconference will be held August 29, 2008 from 8:00 AM to 10:00 AM US Pacific Time. A vote on IBIS 5.0 is scheduled.

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NOTES

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This meeting was conducted in accordance with the GEIA Legal Guides and GEIA Manual of Organization and Procedure.

The following e-mail addresses are used:

majordomo@eda.org

In the body, for the IBIS Open Forum Reflector:
subscribe ibis <your e-mail address>

In the body, for the IBIS Users' Group Reflector:
subscribe ibis-users <your e-mail address>

Help and other commands:
help

ibis-request@eda.org

To join, change, or drop from either or both:
IBIS Open Forum Reflector (ibis@eda.org)
IBIS Users' Group Reflector (ibis-users@eda.org)
State your request.

ibis-info@eda.org

To obtain general information about IBIS, to ask specific questions for individual response, and to inquire about joining the EIA-IBIS Open Forum as a full Member.

ibis@eda.org

To send a message to the general IBIS Open Forum Reflector. This is used mostly for IBIS Standardization business and future IBIS technical enhancements. Job posting information is not permitted.

ibis-users@eda.org

To send a message to the IBIS Users' Group Reflector. This is used mostly for IBIS clarification, current modeling issues, and general user concerns. Job posting information is not permitted.

ibis-bug@eda.org

To report ibischk parser BUGs. The BUG Report Form resides along with reported BUGs at:

<http://www.eda.org/ibis/bugs/ibischk/>
<http://www.eda.org/ibis/bugs/ibischk/bugform.txt>

icm-bug@eda.org

To report icmchk1 parser BUGs. The BUG Report Form resides along with reported BUGs at:

http://www.eda.org/ibis/icm_bugs/
http://www.eda.org/ibis/icm_bugs/icm_bugform.txt

To report s2ibis, s2ibis2 and s2iplt bugs, use the Bug Report Forms which reside at:

<http://www.eda.org/ibis/bugs/s2ibis/bugs2i.txt>
<http://www.eda.org/ibis/bugs/s2ibis2/bugs2i2.txt>
<http://www.eda.org/ibis/bugs/s2iplt/bugsplt.txt>

Information on IBIS technical contents, IBIS participants and actual IBIS models are available on the IBIS Home page:

<http://www.eigroup.org/ibis/ibis.htm>

Check the IBIS file directory on eda.org for more information on previous discussions and results:

<http://www.eda.org/ibis/directory.html>

All eda.org documents can be accessed using a mirror:

<http://www.ibis-information.org>

Note that the "/ibis" text should be removed from directory names when this URL mirror is used.

* Other trademarks, brands and names are the property of their respective owners.

GEIA STANDARDS BALLOT VOTING STATUS

I/O Buffer Information Specification Committee (IBIS)

Organization	Interest Category	Standards Ballot Voting Status	June 10, 2008	June 27, 2008	July 18, 2008	August 8, 2008
Advanced Micro Devices	Producer	Inactive				√
Agilent Technologies	User	Inactive				
Ansoft	User	Inactive				
Apple Computer	User	Inactive				
Applied Simulation Technology	User	Inactive				
ARM	Producer	Inactive				
Cadence Design Systems	User	Active		√		√
Cisco Systems	User	Active	√	√	√	√
Ericsson	Producer	Inactive		√		
Green Streak Programs	General Interest	Inactive	√			
Hitachi ULSI Systems	Producer	Inactive	√			
Huawei	User	Inactive		√		√
IBM	Producer	Active		√		√
Infineon Technologies AG	Producer	Inactive				
Intel Corp.	Producer	Active	√	√	√	√
LSI	Producer	Active		√	√	√
Marvell Semiconductor	Producer	Inactive				
Mentor Graphics	User	Active	√	√	√	√
Micron Technology	Producer	Active			√	√
Nokia Siemens Networks	Producer	Active		√		√
Samtec	Producer	Inactive				
Signal Integrity Software	User	Active	√	√	√	
Sigrity	User	Active	√	√	√	√
Synopsys	User	Inactive				
Teraspeed Consulting	General Interest	Active	√	√	√	√
Texas Instruments	Producer	Inactive	√			√
Toshiba	Producer	Inactive	√			
Xilinx	Producer	Active	√		√	
ZTE	User	Inactive				

CRITERIA FOR MEMBER IN GOOD STANDING:

- MUST ATTEND TWO CONSECUTIVE MEETINGS TO ESTABLISH VOTING MEMBERSHIP
- MEMBERSHIP DUES CURRENT
- MUST NOT MISS TWO CONSECUTIVE MEETINGS

INTEREST CATEGORIES ASSOCIATED WITH GEIA BALLOT VOTING ARE:

- USERS - MEMBERS THAT UTILIZE ELECTRONIC EQUIPMENT TO PROVIDE SERVICES TO AN END USER.
- PRODUCERS - MEMBERS THAT SUPPLY ELECTRONIC EQUIPMENT.
- GENERAL INTEREST - MEMBERS ARE NEITHER PRODUCERS NOR USERS. THIS CATEGORY INCLUDES, BUT IS NOT LIMITED TO, GOVERNMENT, REGULATORY AGENCIES (STATE AND FEDERAL), RESEARCHERS, OTHER ORGANIZATIONS AND ASSOCIATIONS, AND/OR CONSUMERS.